TUITION SCHOLARSHIPS

e are pleased to offer a limited number of full or partial Tuition Scholarships to qualifying consumer advocate organizations, safety net providers, academics, students and health services research organizations to attend the National Bundled Payment Summit.

A variety of factors will be considered in determining the issuance of a scholarship. These factors include financial need and the desirability of geographic and organizational representation at the event(s). Funding for scholarships is limited.

Tuition scholarships cover the cost of the registration fee of the event. Funds are not available to cover travel or lodging.

To apply for a full or partial tuition scholarship please complete and submit this Tuition Scholarship Application form.

For Questions, call (800) 503-7414 (Continental US, Alaska and Hawaii only) - Mon.-Fri., 9 am - 5 pm pacific time or email mail: Registration@HCConferences.com.

TUITION SCHOLARSHIP APPLICATION FORM

Or scan/email to: registration@hcconferences.com.

If you have questions, call 800-503-3597, Ext. 1 or email registration@hcconferences.com

To apply for a full or partial tuition scholarship to attend the National Bundled Payment Summit please complete and submit this Tuition Scholarship Application form. For Questions, call 800-503-9528, Ext. 1 (Continental US, Alaska and Hawaii only) — Mon. – Fri., 7 am – 5 pm pacific time or email: Registration@HCConferences.com.

Name
Title
Organization
Type of Organization
Address
City/State/ZIP
Telephone
Fax
Email
Reasons for requesting scholarship:
Attendance Options:
Please select how you wish to attend: In-Person/Onsite Live Internet/Webcast
Please fax your completed form to: 206-319-5303.
Mail to: Conference Office, 12330 NE 8th Street, Suite 101, Bellevue, WA 98005-3187.